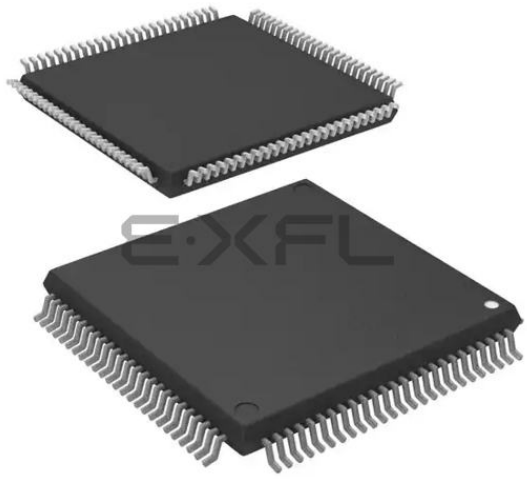
Renesas Electronics America Inc - R5F64167DFB#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	EBI/EMI, I²C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	84
Program Memory Size	640KB (640K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64167dfb-u0

Table 1.4 Performance Overview for the 100-pin Package (2/2)

Unit	Function	Explanation
Timer	Timer A	16-bit timer × 5 Timer mode, event counter mode, one-shot timer mode, pulse-width modulation (PWM) mode Two-phase pulse signal processing in event counter mode (two-phase encoder input) × 3
	Timer B	16-bit timer × 6 Timer mode, event counter mode, pulse frequency measurement mode, pulse-width measurement mode
	Three-phase motor control timer	Three-phase motor control timer × 1 (timers A1, A2, A4, and B2 used) 8-bit programmable dead time timer
Serial Interface	UART0 to UART8	Asynchronous/synchronous serial interface × 9 channels • I^2C-bus (UART0 to UART6) • Special mode 2 (UART0 to UART6) • IEBus (optional (1)) (UART0 to UART6)
A/D Converter		10-bit resolution × 26 channels Sample and hold functionality integrated
D/A Converter		8-bit resolution × 2
CRC Calculator		CRC-CCITT ($X^{16} + X^{12} + X^5 + 1$)
X-Y Converter		16 bits × 16 bits
Intelligent I/O		Time measurement (input capture): 16 bits × 16 Waveform generation (output compare): 16 bits × 19 Serial interface: Variable-length synchronous serial I/O mode, IEBus mode (optional (1))
Multi-master I^2C-bus Interface		1 channel
Flash Memory		Programming and erasure supply voltage: VCC = 3.0 to 5.5 V Minimum endurance: 1,000 program/erase cycles Security protection: ROM code protect, ID code protect Debugging: On-chip debug, on-board flash programming
Operating Frequency/Supply Voltage		64 MHz (high speed version)/VCC = 3.0 to 5.5 V 50 MHz (normal speed version)/VCC = 3.0 to 5.5 V
Operating Temperature		-20°C to 85°C (N version) -40°C to 85°C (D version) -40°C to 85°C (P version)
Current Consumption		45 mA (VCC = 5.0 V, f(CPU) = 64 MHz) 35 mA (VCC = 5.0 V, f(CPU) = 50 MHz) 8 µA (VCC = 3.3 V, f(XCIN) = 32.768 kHz, in wait mode)
Package		100-pin plastic molded LQFP (PLQP0100KB-A)

Note:
1. Contact a Renesas Electronics sales office to use the optional features.

Table 1.7 Pin Characteristics for the 144-pin Package (1/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
1		P9_6			TXD4/SDA4/SRXD4		ANEX1	
2		P9_5			CLK4		ANEX0	
3		P9_4		TB4IN	$\overline{CTS4}$/$\overline{RTS4}$/$\overline{SS4}$		DA1	
4		P9_3		TB3IN	$\overline{CTS3}$/$\overline{RTS3}$/$\overline{SS3}$		DA0	
5		P9_2		TB2IN	TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/ IEOUT		
6		P9_1		TB1IN	RXD3/SCL3/STXD3	ISRXD2/IEIN		
7		P9_0		TB0IN	CLK3			
8		P14_6	$\overline{INT8}$					
9		P14_5	$\overline{INT7}$					
10		P14_4	$\overline{INT6}$					
11		P14_3						
12	VDC0							
13		P14_1						
14	VDC1							
15	NSD							
16	CNVSS							
17	XCIN	P8_7						
18	XCOUT	P8_6						
19	$\overline{RESET}$							
20	XOUT							
21	VSS							
22	XIN							
23	VCC							
24		P8_5	$\overline{NMI}$					
25		P8_4	$\overline{INT2}$					
26		P8_3	$\overline{INT1}$					
27		P8_2	$\overline{INT0}$					
28		P8_1		TA4IN/$\overline{U}$	$\overline{CTS5}$/$\overline{RTS5}$/$\overline{SS5}$	IIO1_5/UD0B/UD1B		
29		P8_0		TA4OUT/U	RXD5/SCL5/STXD5	UD0A/UD1A		
30		P7_7		TA3IN	CLK5	IIO1_4/UD0B/UD1B		
31		P7_6		TA3OUT	TXD5/SDA5/SRXD5/ $\overline{CTS8}$/$\overline{RTS8}$	IIO1_3/UD0A/UD1A		
32		P7_5		TA2IN/$\overline{W}$	RXD8	IIO1_2		
33		P7_4		TA2OUT/W	CLK8	IIO1_1		
34		P7_3		TA1IN/$\overline{V}$	$\overline{CTS2}$/$\overline{RTS2}$/$\overline{SS2}$/TXD8	IIO1_0		
35		P7_2		TA1OUT/V	CLK2			
36		P7_1		TA0IN/ TB5IN	RXD2/SCL2/STXD2/ MSCL	IIO1_7/OUTC2_2/ ISRXD2/IEIN		

Table 1.10 Pin Characteristics for the 144-pin Package (4/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
115		P11_3			$\overline{\text{CTS8}}$/$\overline{\text{RTS8}}$	IIO1_3		$\overline{\text{CS3}}$/$\overline{\text{WR2}}$
116		P11_2			RXD8	IIO1_2		$\overline{\text{CS2}}$
117		P11_1			CLK8	IIO1_1		$\overline{\text{CS1}}$
118		P11_0			TXD8	IIO1_0		$\overline{\text{CS0}}$
119		P0_3					AN0_3	D3
120		P0_2					AN0_2	D2
121		P0_1					AN0_1	D1
122		P0_0					AN0_0	D0
123		P15_7			$\overline{\text{CTS6}}$/$\overline{\text{RTS6}}$/$\overline{\text{SS6}}$	IIO0_7	AN15_7	
124		P15_6			CLK6	IIO0_6	AN15_6	
125		P15_5			RXD6/SCL6/STXD6	IIO0_5	AN15_5	
126		P15_4			TXD6/SDA6/SRXD6	IIO0_4	AN15_4	
127		P15_3			$\overline{\text{CTS7}}$/$\overline{\text{RTS7}}$	IIO0_3	AN15_3	
128		P15_2			RXD7	IIO0_2	AN15_2	
129		P15_1			CLK7	IIO0_1	AN15_1	
130	VSS							
131		P15_0			TXD7	IIO0_0	AN15_0	
132	VCC							
133		P10_7	$\overline{\text{KI3}}$				AN_7	
134		P10_6	$\overline{\text{KI2}}$				AN_6	
135		P10_5	$\overline{\text{KI1}}$				AN_5	
136		P10_4	$\overline{\text{KI0}}$				AN_4	
137		P10_3					AN_3	
138		P10_2					AN_2	
139		P10_1					AN_1	
140	AVSS							
141		P10_0					AN_0	
142	VREF							
143	AVCC							
144		P9_7			RXD4/SCL4/STXD4		$\overline{\text{ADTRG}}$	

Table 1.13 Pin Characteristics for the 100-pin Package (3/3)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
76		P1_2				IIO0_2/IIO1_2		D10
77		P1_1				IIO0_1/IIO1_1		D9
78		P1_0				IIO0_0/IIO1_0		D8
79		P0_7					AN0_7	D7
80		P0_6					AN0_6	D6
81		P0_5					AN0_5	D5
82		P0_4					AN0_4	D4
83		P0_3					AN0_3	D3
84		P0_2					AN0_2	D2
85		P0_1					AN0_1	D1
86		P0_0					AN0_0	D0
87		P10_7	$\overline{KI3}$				AN_7	
88		P10_6	$\overline{KI2}$				AN_6	
89		P10_5	$\overline{KI1}$				AN_5	
90		P10_4	$\overline{KI0}$				AN_4	
91		P10_3					AN_3	
92		P10_2					AN_2	
93		P10_1					AN_1	
94	AVSS							
95		P10_0					AN_0	
96	VREF							
97	AVCC							
98		P9_7			RXD4/SCL4/STXD4		$\overline{ADTRG}$	
99		P9_6			TXD4/SDA4/SRXD4		ANEX1	
100		P9_5			CLK4		ANEX0	

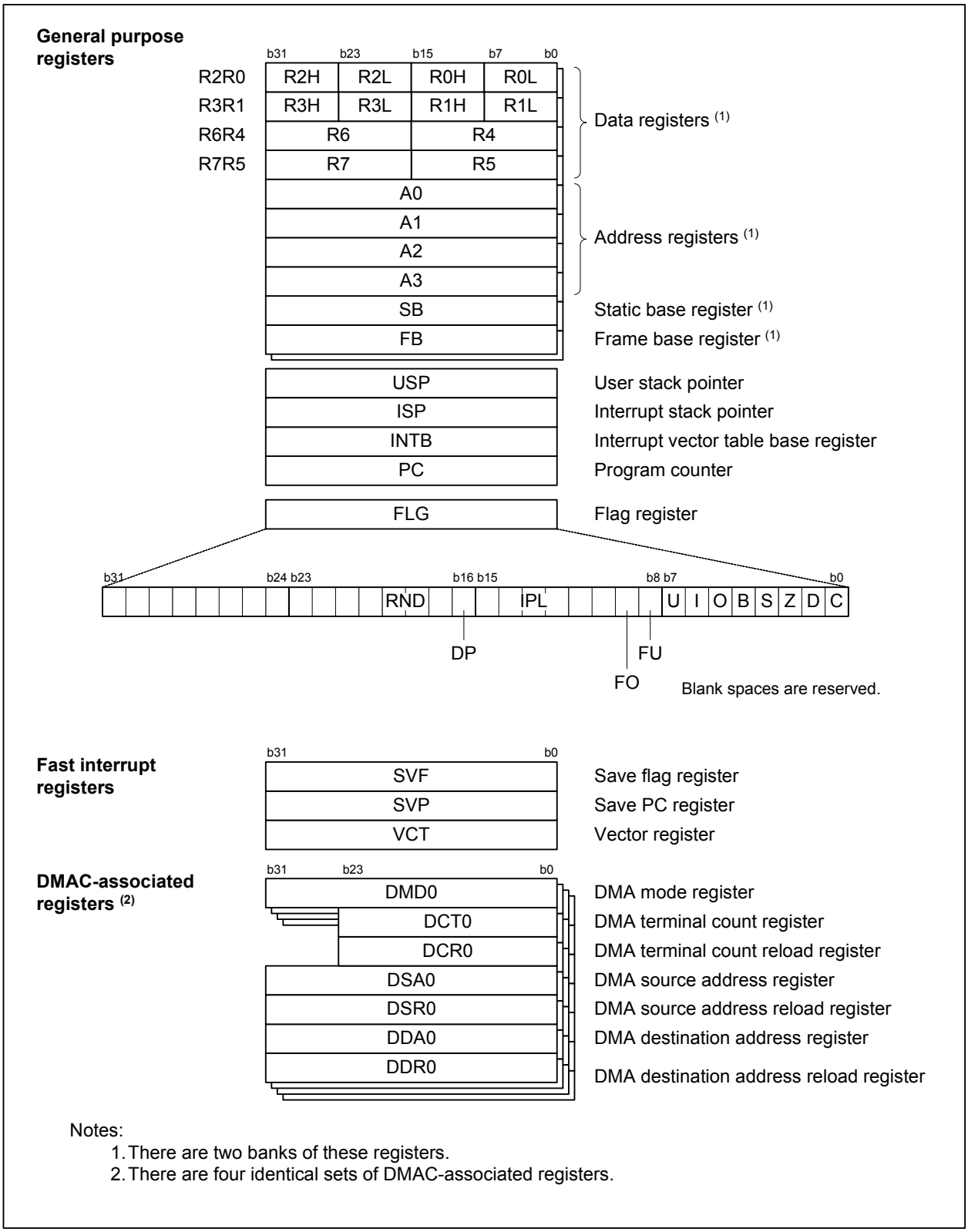
Table 1.16 Pin Definitions and Functions (3/4)

Function	Symbol	I/O	Description
I/O port (1, 2)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7	I/O	I/O ports in CMOS. Each port can be programmed to input or output under the control of the direction register. Some ports are 5 V tolerant inputs. Pull-up resistors and N-channel open drain setting can be enabled on some ports. Refer to Table 1.18 “Pin Specifications” for details
Input port (2)	P9_1 (for 100-pin package) P14_1 (for 144-pin package)	I	Input port in CMOS Pull-up resistor is selectable. Refer to Table 1.18 “Pin Specifications” for details
Timer A	TA0OUT to TA4OUT	I/O	Timers A0 to A4 input/output
	TA0IN to TA4IN	I	Timers A0 to A4 input
Timer B	TB0IN to TB5IN	I	Timers B0 to B5 input
Three-phase motor control timer output	U, $\overline{U}$, V, $\overline{V}$, W, $\overline{W}$	O	Three-phase motor control timer output
Serial interface	$\overline{CTS0}$ to $\overline{CTS8}$	I	Handshake input
	$\overline{RTS0}$ to $\overline{RTS8}$	O	Handshake output
	CLK0 to CLK8	I/O	Transmit/receive clock input/output
	RXD0 to RXD8	I	Serial data input
	TXD0 to TXD8	O	Serial data output
I^2C-bus (simplified)	SDA0 to SDA6	I/O	Serial data input/output
	SCL0 to SCL6	I/O	Transmit/receive clock input/output
Serial interface special functions	STXD0 to STXD6	O	Serial data output in slave mode
	SRXD0 to SRXD6	I	Serial data input in slave mode
	$\overline{SS0}$ to $\overline{SS6}$	I	Input to control serial interface special functions

Notes:
1. Port P9_1 in the 100-pin package is an input-only port.
2. Ports P9_0, P9_2, and P11 to P15 are available in the 144-pin package only.

2. Central Processing Unit (CPU)

The CPU contains the registers shown below. There are two register banks each consisting of registers R2R0, R3R1, R6R4, R7R5, A0 to A3, SB, and FB.



Notes:
1. There are two banks of these registers.
2. There are four identical sets of DMAC-associated registers.

Figure 2.1 CPU Registers

2.1.8.5 Register Bank Select Flag (B flag)

This flag selects a register bank. It indicates 0 when register bank 0 is selected, and 1 when register bank 1 is selected.

2.1.8.6 Overflow Flag (O flag)

This flag becomes 1 when the result of an operation overflows; otherwise it is 0.

2.1.8.7 Interrupt Enable Flag (I flag)

This flag enables maskable interrupts. To disable maskable interrupts, set this flag to 0. To enable them, set this flag to 1. When an interrupt is accepted, the flag becomes 0.

2.1.8.8 Stack Pointer Select Flag (U flag)

To select the interrupt stack pointer (ISP), set this flag to 0. To select the user stack pointer (USP), set this flag to 1.
It becomes 0 when a hardware interrupt is accepted or when an INT instruction designated by a software interrupt number from 0 to 127 is executed.

2.1.8.9 Floating-point Underflow Flag (FU flag)

This flag becomes 1 when an underflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

2.1.8.10 Floating-point Overflow Flag (FO flag)

This flag becomes 1 when an overflow occurs in a floating-point operation; otherwise it is 0. It also becomes 1 when the operand contains invalid numbers (subnormal numbers).

2.1.8.11 Processor Interrupt Priority Level (IPL)

The processor interrupt priority level (IPL), consisting of 3 bits, selects a processor interrupt priority level from level 0 to 7. An interrupt is enabled when the interrupt request level is higher than the selected IPL.
When the processor interrupt priority level (IPL) is set to 111b (level 7), all interrupts are disabled.

2.1.8.12 Fixed-point Radix Point Designation Bit (DP bit)

This bit designates the radix point. It also specifies which portion of the fixed-point multiplication result to extract. It is used for the MULX instruction.

2.1.8.13 Floating-point Rounding Mode (RND)

The 2-bit floating-point rounding mode selects a rounding mode for floating-point calculation results.

2.1.8.14 Reserved

Only set this bit to 0. The read value is undefined.

Table 4.13 SFR List (13)

Address	Register	Symbol	Reset Value
000320h			
000321h			
000322h			
000323h			
000324h	UART3 Special Mode Register 4	U3SMR4	00h
000325h	UART3 Special Mode Register 3	U3SMR3	00h
000326h	UART3 Special Mode Register 2	U3SMR2	00h
000327h	UART3 Special Mode Register	U3SMR	00h
000328h	UART3 Transmit/Receive Mode Register	U3MR	00h
000329h	UART3 Bit Rate Register	U3BRG	XXh
00032Ah	UART3 Transmit Buffer Register	U3TB	XXXXh
00032Bh			
00032Ch	UART3 Transmit/Receive Control Register 0	U3C0	0000 1000b
00032Dh	UART3 Transmit/Receive Control Register 1	U3C1	0000 0010b
00032Eh	UART3 Receive Buffer Register	U3RB	XXXXh
00032Fh			
000330h			
000331h			
000332h			
000333h			
000334h	UART2 Special Mode Register 4	U2SMR4	00h
000335h	UART2 Special Mode Register 3	U2SMR3	00h
000336h	UART2 Special Mode Register 2	U2SMR2	00h
000337h	UART2 Special Mode Register	U2SMR	00h
000338h	UART2 Transmit/Receive Mode Register	U2MR	00h
000339h	UART2 Bit Rate Register	U2BRG	XXh
00033Ah	UART2 Transmit Buffer Register	U2TB	XXXXh
00033Bh			
00033Ch	UART2 Transmit/Receive Control Register 0	U2C0	0000 1000b
00033Dh	UART2 Transmit/Receive Control Register 1	U2C1	0000 0010b
00033Eh	UART2 Receive Buffer Register	U2RB	XXXXh
00033Fh			
000340h	Count Start Register	TABSR	0000 0000b
000341h	Clock Prescaler Reset Register	CPSRF	0XXX XXXXb
000342h	One-shot Start Register	ONSF	0000 0000b
000343h	Trigger Select Register	TRGSR	0000 0000b
000344h	Increment/Decrement Select Register	UDF	0000 0000b
000345h			
000346h	Timer A0 Register	TA0	XXXXh
000347h			
000348h	Timer A1 Register	TA1	XXXXh
000349h			
00034Ah	Timer A2 Register	TA2	XXXXh
00034Bh			
00034Ch	Timer A3 Register	TA3	XXXXh
00034Dh			
00034Eh	Timer A4 Register	TA4	XXXXh
00034Fh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.17 SFR List (17)

Address	Register	Symbol	Reset Value
0003E0h			
0003E1h			
0003E2h			
0003E3h			
0003E4h			
0003E5h			
0003E6h			
0003E7h			
0003E8h			
0003E9h			
0003EAh			
0003EBh			
0003ECh			
0003EDh			
0003EEh			
0003EFh			
0003F0h	Pull-up Control Register 0	PUR0	0000 0000b
0003F1h	Pull-up Control Register 1	PUR1	XXXX X0XXb
0003F2h	Pull-up Control Register 2	PUR2	000X XXXXb
0003F3h	Pull-up Control Register 3	PUR3	0000 0000b
0003F4h	Pull-up Control Register 4	PUR4	XXXX 0000b
0003F5h			
0003F6h			
0003F7h			
0003F8h			
0003F9h			
0003FAh			
0003FBh			
0003FCh			
0003FDh			
0003FEh			
0003FFh	Port Control Register	PCR	0XXX XXX0b

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.18 SFR List (18)

Address	Register	Symbol	Reset Value
040000h	Flash Memory Control Register 0	FMR0	0X01 XX00b
040001h	Flash Memory Status Register 0	FMSR0	1000 0000b
040002h			
040003h			
040004h			
040005h			
040006h			
040007h			
040008h	Flash Register Protection Unlock Register 0	FPR0	00h
040009h	Flash Memory Control Register 1	FMR1	0000 0010b
04000Ah	Block Protect Bit Monitor Register 0	FBPM0	??X? ????b (1)
04000Bh	Block Protect Bit Monitor Register 1	FBPM1	XXX? ????b (1)
04000Ch			
04000Dh			
04000Eh			
04000Fh			
040010h			
040011h	Block Protect Bit Monitor Register 2	FBPM2	???? ????b (1)
040012h			
040013h			
040014h			
040015h			
040016h			
040017h			
040018h			
040019h			
04001Ah			
04001Bh			
04001Ch			
04001Dh			
04001Eh			
04001Fh			
040020h	PLL Control Register 0	PLC0	0000 0001b
040021h	PLL Control Register 1	PLC1	0001 1111b
040022h			
040023h			
040024h			
040025h			
040026h			
040027h			
040028h			
040029h			
04002Ah			
04002Bh			
04002Ch			
04002Dh			
04002Eh			
04002Fh			

X: Undefined
Blanks are reserved. No access is allowed.

Note:
1. The reset value reflects the value of the protect bit for each block in the flash memory.

Table 4.20 SFR List (20)

Address	Register	Symbol	Reset Value
040094h			
040095h			
040096h			
040097h	Three-phase Output Buffer Control Register	IOBC	0XXX XXXXb
040098h	Input Function Select Register 0	IFS0	X000 0000b
040099h			
04009Ah	Input Function Select Register 2	IFS2	0000 00X0b
04009Bh	Input Function Select Register 3	IFS3	XXXX XX00b
04009Ch			
04009Dh			
04009Eh			
04009Fh			
0400A0h	Port P0_0 Function Select Register	P0_0S	0XXX X000b
0400A1h	Port P1_0 Function Select Register	P1_0S	XXXX X000b
0400A2h	Port P0_1 Function Select Register	P0_1S	0XXX X000b
0400A3h	Port P1_1 Function Select Register	P1_1S	XXXX X000b
0400A4h	Port P0_2 Function Select Register	P0_2S	0XXX X000b
0400A5h	Port P1_2 Function Select Register	P1_2S	XXXX X000b
0400A6h	Port P0_3 Function Select Register	P0_3S	0XXX X000b
0400A7h	Port P1_3 Function Select Register	P1_3S	XXXX X000b
0400A8h	Port P0_4 Function Select Register	P0_4S	0XXX X000b
0400A9h	Port P1_4 Function Select Register	P1_4S	XXXX X000b
0400AAh	Port P0_5 Function Select Register	P0_5S	0XXX X000b
0400ABh	Port P1_5 Function Select Register	P1_5S	XXXX X000b
0400ACh	Port P0_6 Function Select Register	P0_6S	0XXX X000b
0400ADh	Port P1_6 Function Select Register	P1_6S	XXXX X000b
0400AEh	Port P0_7 Function Select Register	P0_7S	0XXX X000b
0400AFh	Port P1_7 Function Select Register	P1_7S	XXXX X000b
0400B0h	Port P2_0 Function Select Register	P2_0S	0XXX X000b
0400B1h	Port P3_0 Function Select Register	P3_0S	XXXX X000b
0400B2h	Port P2_1 Function Select Register	P2_1S	0XXX X000b
0400B3h	Port P3_1 Function Select Register	P3_1S	XXXX X000b
0400B4h	Port P2_2 Function Select Register	P2_2S	0XXX X000b
0400B5h	Port P3_2 Function Select Register	P3_2S	XXXX X000b
0400B6h	Port P2_3 Function Select Register	P2_3S	0XXX X000b
0400B7h	Port P3_3 Function Select Register	P3_3S	XXXX X000b
0400B8h	Port P2_4 Function Select Register	P2_4S	0XXX X000b
0400B9h	Port P3_4 Function Select Register	P3_4S	XXXX X000b
0400BAh	Port P2_5 Function Select Register	P2_5S	0XXX X000b
0400BBh	Port P3_5 Function Select Register	P3_5S	XXXX X000b
0400BCh	Port P2_6 Function Select Register	P2_6S	0XXX X000b
0400BDh	Port P3_6 Function Select Register	P3_6S	XXXX X000b
0400BEh	Port P2_7 Function Select Register	P2_7S	0XXX X000b
0400BFh	Port P3_7 Function Select Register	P3_7S	XXXX X000b

X: Undefined
Blanks are reserved. No access is allowed.

Table 5.2 Operating Conditions (1/5) (1)

Symbol	Characteristic			Value			Unit
				Min.	Typ.	Max.	
V_{CC}	Digital supply voltage			3.0	5.0	5.5	V
AV_{CC}	Analog supply voltage				V_{CC}		V
V_{REF}	Reference voltage			3.0		V_{CC}	V
V_{SS}	Digital ground voltage				0		V
AV_{SS}	Analog ground voltage				0		V
dV_{CC}/dt	V_{CC} ramp up rate (V_{CC} < 2.0 V)			0.05			V/ms
V_{IH}	High level input voltage	XIN, $\overline{\text{RESET}}$, CNVSS, NSD, P2_0 to P2_7, P3_0 to P3_7, P5_0 to P5_3, P8_4 to P8_7 (2), P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P14_1, P14_3 to P14_6, P15_0 to P15_7 (3)		0.8 × V_{CC}		V_{CC}	V
		P4_0 to P4_7, P5_4 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_3		0.8 × V_{CC}		6.0	V
		P0_0 to P0_7, P1_0 to P1_7, P12_0 to P12_7, P13_0 to P13_7 (3)	in single-chip mode	0.8 × V_{CC}		V_{CC}	V
			in memory expansion mode or microprocessor mode	0.5 × V_{CC}		V_{CC}	V
V_{IL}	Low level input voltage	XIN, $\overline{\text{RESET}}$, CNVSS, NSD, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7 (2), P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P14_1, P14_3 to P14_6, P15_0 to P15_7 (3)		0		0.2 × V_{CC}	V
		P0_0 to P0_7, P1_0 to P1_7, P12_0 to P12_7, P13_0 to P13_7 (3)	in single-chip mode	0		0.2 × V_{CC}	V
			in memory expansion mode or microprocessor mode	0		0.16 × V_{CC}	V
T_{opr}	Operating temperature range	N version		-20		85	°C
		D version		-40		85	°C
		P version		-40		85	°C

Notes:
1. The device is operationally guaranteed under these operating conditions.
2. V_{IH} and V_{IL} for P8_7 are specified for P8_7 as a programmable port. These values are not applicable for P8_7 as XCIN.
3. Ports P9_0, P9_2, and P11 to P15 are available in the 144-pin package only. Port P9_1 is designated as input pin in the 100-pin package.

Table 5.5 Operating Conditions (4/5)

(V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted) (1)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
$f_{(XIN)}$	Main clock oscillator frequency		4		16	MHz
$f_{(XRef)}$	Reference clock frequency		2		4	MHz
$f_{(PLL)}$	PLL clock oscillator frequency		96		128	MHz
$f_{(Base)}$	Base clock frequency	High speed version			64	MHz
		Normal speed version			50	MHz
$t_{c(Base)}$	Base clock cycle time	High speed version	15.625			ns
		Normal speed version	20			ns
$f_{(CPU)}$	CPU operating frequency	High speed version			64	MHz
		Normal speed version			50	MHz
$t_{c(CPU)}$	CPU clock cycle time	High speed version	15.625			ns
		Normal speed version	20			ns
$f_{(BCLK)}$	Peripheral bus clock operating frequency	High speed version			32	MHz
		Normal speed version			25	MHz
$t_{c(BCLK)}$	Peripheral bus clock cycle time	High speed version	31.25			ns
		Normal speed version	40			ns
$f_{(PER)}$	Peripheral clock source frequency				32	MHz
$f_{(XCIN)}$	Sub clock oscillator frequency			32.768	62.5	kHz

Note:
1. The device is operationally guaranteed under these operating conditions.

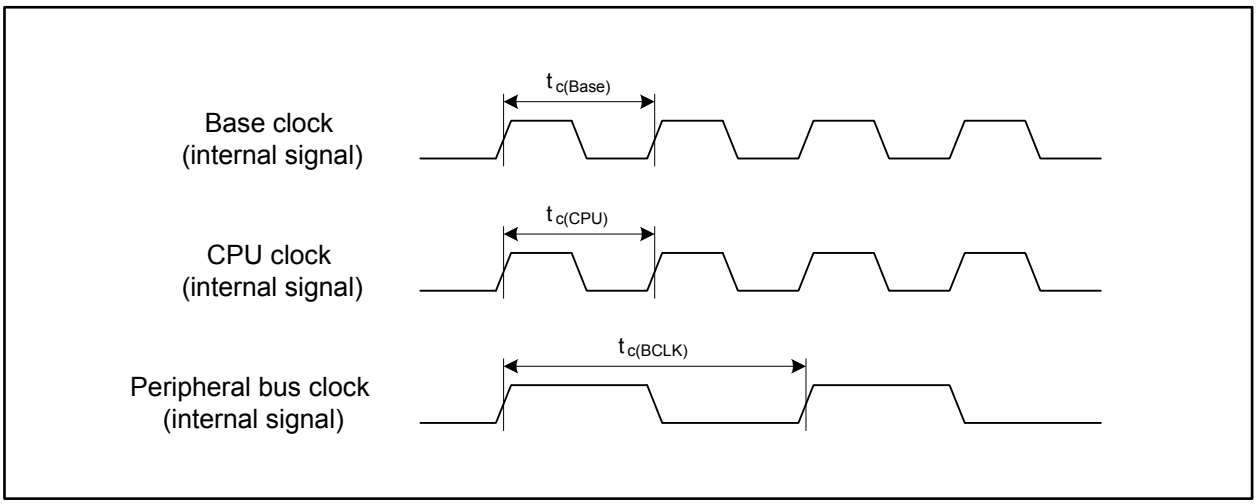


Figure 5.1 Clock Cycle Time

Timing Requirements (V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and Ta = T_{opr}, unless otherwise noted)

Table 5.14 Flash Memory CPU Rewrite Mode Timing

Symbol	Characteristics	Value		Unit
		Min.	Max.	
t_{cR}	Read cycle time	200		ns
$t_{su(S-R)}$	Chip-select setup time before read	200		ns
$t_{h(R-S)}$	Chip-select hold time after read	0		ns
$t_{su(A-R)}$	Address setup time before read	200		ns
$t_{h(R-A)}$	Address hold time after read	0		ns
$t_{w(R)}$	Read pulse width	100		ns
t_{cW}	Write cycle time	200		ns
$t_{su(S-W)}$	Chip-select setup time before write	0		ns
$t_{h(W-S)}$	Chip-select hold time after write	30		ns
$t_{su(A-W)}$	Address setup time before write	0		ns
$t_{h(W-A)}$	Address hold time after write	30		ns
$t_{w(W)}$	Write pulse width	50		ns

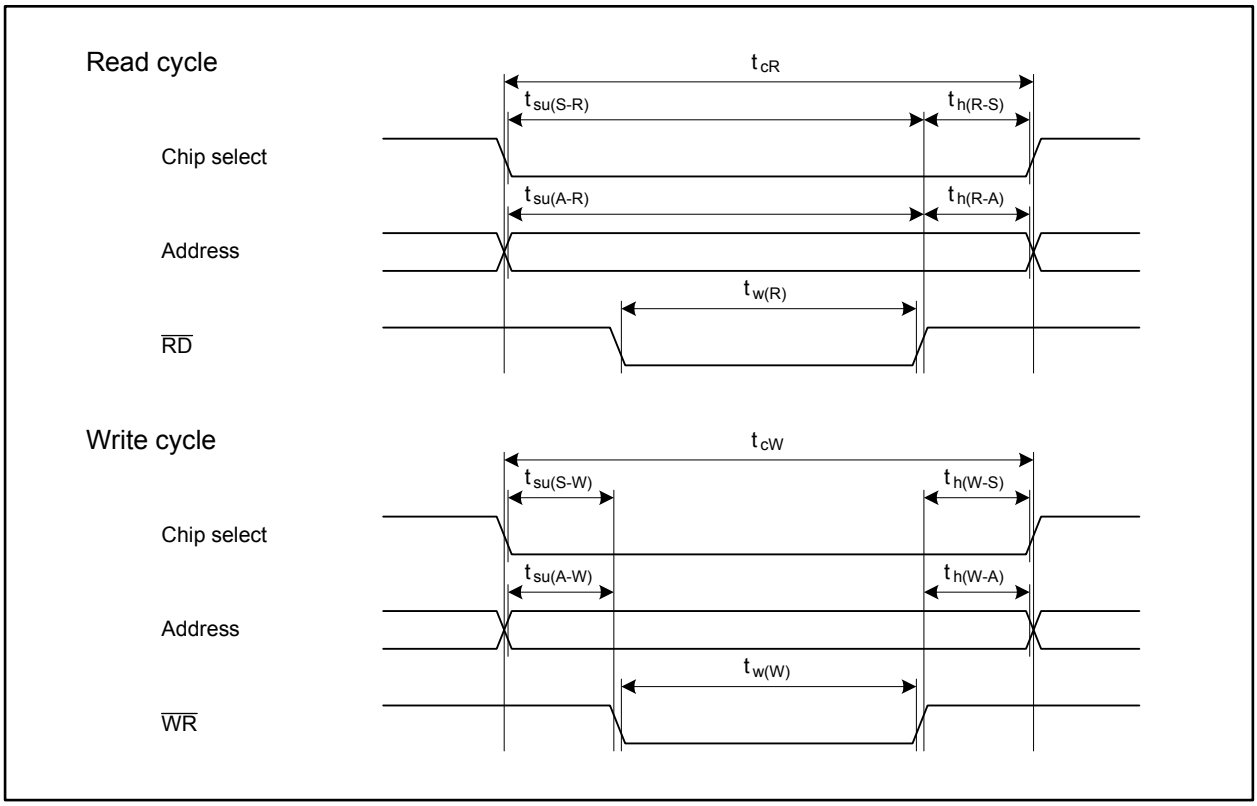


Figure 5.5 Flash Memory CPU Rewrite Mode Timing

V_{CC} = 5 V

Switching Characteristics (V_{CC} = 4.2 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.36 External Bus Timing (multiplexed bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-ALE)}$	Chip-select setup time before ALE	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		1.5 × $t_{c(Base)}$ - 15		ns
$t_{su(A-ALE)}$	Address setup time before ALE		(1)		ns
$t_{h(ALE-A)}$	Address hold time after ALE		0.5 × $t_{c(Base)}$ - 5		ns
$t_{h(R-A)}$	Address hold time after read		1.5 × $t_{c(Base)}$ - 15		ns
$t_{d(ALE-R)}$	ALE-read delay time		0.5 × $t_{c(Base)}$ - 5	0.5 × $t_{c(Base)}$ + 10	ns
$t_{w(ALE)}$	ALE pulse width		(1)		ns
$t_{dis(R-A)}$	Address disable time after read			8	ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{h(W-A)}$	Address hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{d(ALE-W)}$	ALE-write delay time		0.5 × $t_{c(Base)}$ - 5	0.5 × $t_{c(Base)}$ + 10	ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		0.5 × $t_{c(Base)}$		ns

Note:

1. The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of Tsu(A-R), Tw(R), Tsu(A-W), and Tw(W) set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

   $t_{su(S-ALE)}$ = $t_{su(A-ALE)}$ = $t_{w(ALE)}$ = (Tsu(A-R) - 0.5) × $t_{c(Base)}$ -15 [ns]

   $t_{w(R)}$ = Tw(R) × $t_{c(Base)}$ -10 [ns]

   $t_{w(W)}$ = $t_{su(D-W)}$ = Tw(W) × $t_{c(Base)}$ -10 [ns]

V_{CC} = 3.3 V

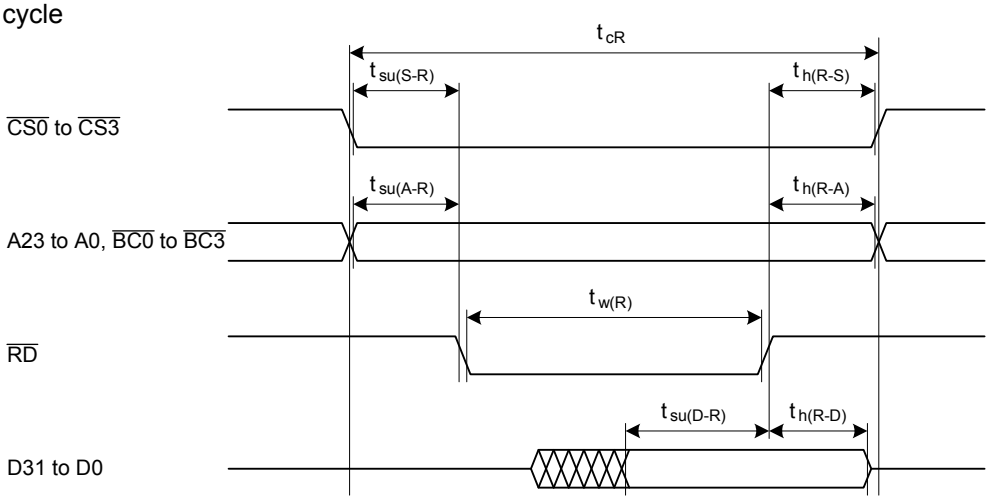
Table 5.44 A/D Conversion Characteristics (V_{CC} = AV_{CC} = V_{REF} = 3.0 to 3.6 V, V_{SS} = AV_{SS} = 0 V, T_a = T_{opr}, and $f_{(BCLK)}$ = 32 MHz, unless otherwise noted)

Symbol	Characteristic	Measurement Condition		Value			Unit
				Min.	Typ.	Max.	
—	Resolution	V_{REF} = V_{CC}				10	Bits
—	Absolute error	V_{REF} = V_{CC} = 3.3 V	AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 (1)			±5	LSB
			External op-amp connection mode			±7	LSB
INL	Integral non-linearity error	V_{REF} = V_{CC} = 3.3 V	AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 (1)			±5	LSB
			External op-amp connection mode			±7	LSB
DNL	Differential non-linearity error	V_{REF} = V_{CC} = 3.3 V				±1	LSB
—	Offset error					±3	LSB
—	Gain error					±3	LSB
R_{LADDER}	Resistor ladder	V_{REF} = V_{CC}		4		20	kΩ
t_{CONV}	Conversion time (10 bits)	ϕ_{AD} = 10 MHz, with sample and hold function		3.3			µs
t_{CONV}	Conversion time (8 bits)	ϕ_{AD} = 10 MHz, with sample and hold function		2.8			µs
t_{SAMP}	Sampling time	ϕ_{AD} = 10 MHz		0.3			µs
V_{IA}	Analog input voltage			0		V_{REF}	V
ϕ_{AD}	Operating clock frequency	Without sample and hold function		0.25		10	MHz
		With sample and hold function		1		10	MHz

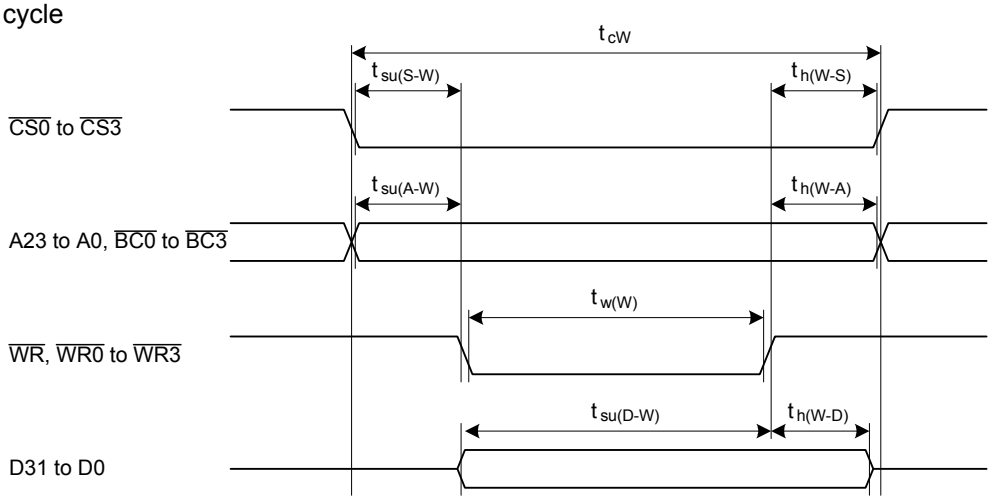
Note:
1. Pins AN15_0 to AN15_7 are available in the 144-pin package only.

External bus timing (separate bus)

Read cycle



Write cycle



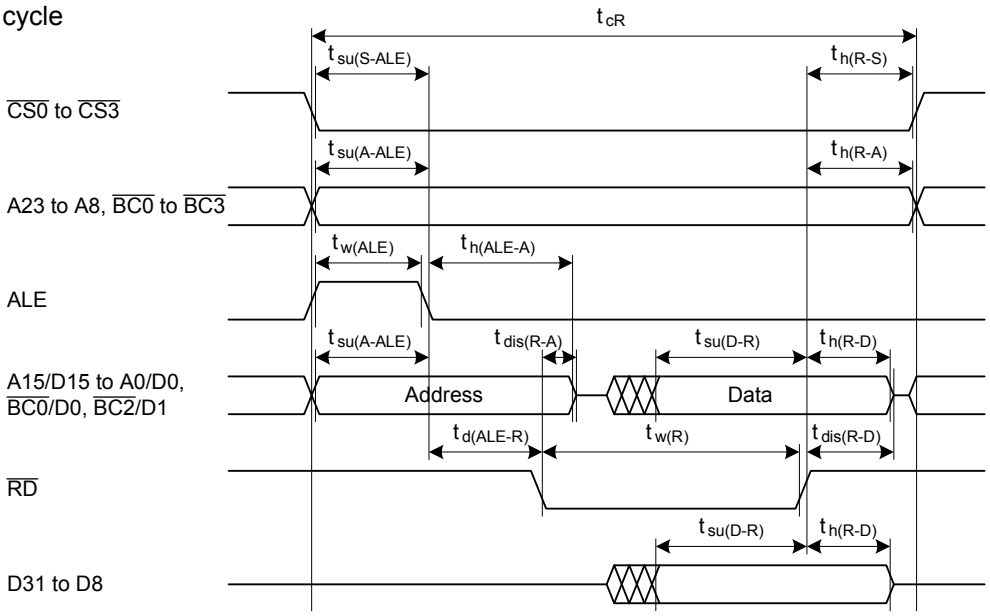
Measurement conditions

Item		V_{CC} = 4.2 to 5.5 V	V_{CC} = 3.0 to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

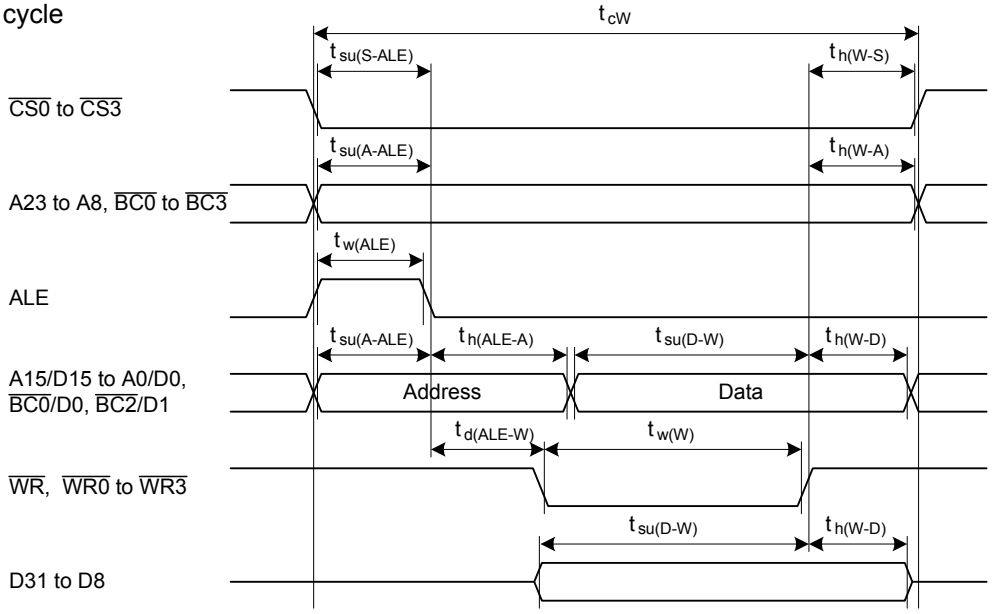
Figure 5.8 External Bus Timing for Separate Bus

External bus timing (multiplexed bus)

Read cycle



Write cycle



Measurement conditions

Item		V_{CC} = 4.2 to 5.5 V	V_{CC} = 3.0 to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

Figure 5.9 External Bus Timing for Multiplexed Bus

Revision History	R32C/116 Group Datasheet

Rev.	Date	Description	
		Page	Summary
1.00	Nov 19, 2009	—	Initial release
1.10	Jun 23, 2010	—	Second edition released
		—	This manual in general • Applied new Renesas templates and formats to the manual • Changed company name to “Renesas Electronics Corporation” and changed related descriptions due to business merger of Renesas Technology Corporation and NEC Electronics Corporation (under Chapters 1 and 5) • Added specifications of 64 MHz version
			Chapter 1. Overview
		3, 5	• Deleted Note 1 from **Tables 1.2 and 1.4**
		9	• Deleted Note 4 from **Figure 1.2**
		19	• Modified expression “fC” in **Table 1.14** to “low speed clocks”
			Chapter 4. SFRs
		34, 37	• Changed register name “Group i Timer Measurement Prescaler Register” in **Tables 4.6 and 4.9** to “Group i Time Measurement Prescaler Register”
		39	• Modified expression “XY Control Register” in **Table 4.11** to “X-Y Control Register”
		41	• Changed register name “UART2 Transmission/Receive Mode Register” in **Table 4.13** to “UART2 Transmit/Receive Mode Register”; Changed hexadecimal format of reset values for registers TABSR, ONSF, and TRGSR to binary
		52	• Changed register name “External Interrupt Source Select Register i” in **Table 4.24** to “External Interrupt Request Source Select Register i”
			Chapter 5. Electrical Characteristics
		63	• Changed expressions “$\overline{CS0}$” and “A23 to A0, $\overline{BC3}$ to $\overline{BC0}$” in **Figure 5.5** to “Chip select” and “Address”, respectively
			Appendix 1. Package Dimensions
		95	• Added a seating plane to the drawing of package dimension
1.20	Feb 6, 2013	—	Third edition released
		—	This manual in general • Changed document number “REJ03B0253-0110” to “R01DS0063EJ0120” • Modified expressions “version N”, “version D”, and “version P” to “N version”, “D version”, and “P version”, respectively (under Chapters 1 and 5)
			Chapter 1. Overview
		—	• Modified wording and enhanced description in this chapter
		2, 4	• Modified expressions “Main clock oscillator stop/re-oscillation detection”, “calculation transfer”, “chained transfer”, and “inputs/outputs” in **Tables 1.1 and 1.3** to “Main clock oscillator stop/restart detection”, “calculation result transfer”, “chain transfer”, and “I/O ports”, respectively
		7	• Completed “under development” phase of versions D and P products in **Table 1.6**

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